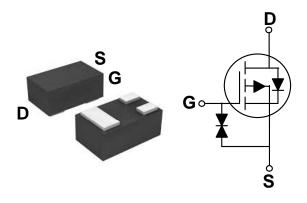


### **General Description**

These P-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

BV <sub>DSS</sub>	R <sub>DS(ON)</sub>	$I_D$
-20 V	$650~\text{m}\Omega$	-250 mA

#### SOT-883 Pin Configuration



### **Features**

- -20V, -250mA,  $R_{DS(ON)}$ =650m $\Omega$ @ $V_{GS}$ = -4.5V
- · Improved dv/dt capability
- · Fast switching
- · Green Device Available
- · Suit for -1.5V Gate Drive Applications

### **Applications**

- Notebook
- · Load Switch
- Battery Protection
- · Hand-held Instruments

Absolute Maximum Ratings T <sub>C</sub> =25°C unless otherwise noted						
Symbol	Parameter	Rating	Units			
$V_{DS}$	Drain-Source Voltage	-20	V			
$V_{GS}$	Gate-Source Voltage	±8	V			
ı	Drain Current - Continuous (T <sub>C</sub> =25°C)	-250	mA			
I <sub>D</sub>	Drain Current - Continuous (T <sub>C</sub> =100°C)	-160	mA			
I <sub>DM</sub>	Drain Current - Pulsed (NOTE 1)	-1	Α			
$P_{D}$	Power Dissipation (T <sub>C</sub> =25°C)	155	mW			
' D	Power Dissipation – Derate above 25°C	1.25	mW/°C			
$T_J$	Operating Junction Temperature Range	-50 to 150	°C			
T <sub>STG</sub>	Storage Temperature Range	-50 to 150	°C			

Thermal Characteristics					
Symbol	Symbol Parameter Typ. Max		Max.	Unit	
$R_{\theta JA}$	Thermal Resistance Junction to Ambient		800	°C/W	





## Electrical Characteristics (T<sub>J</sub>=25°C, unless otherwise noted)

#### **Off Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0V , I <sub>D</sub> = -250uA	-20			V
I <sub>DSS</sub>	IDrain-Source Leakage Current	$V_{DS}$ = -20V , $V_{GS}$ = 0V , $T_{J}$ =25°C			-1	uA
		$V_{DS}$ = -16V , $V_{GS}$ = 0V , $T_J$ =125 $^{\circ}$ C			-10	uA
$I_{GSS}$	Gate-Source Leakage Current	$V_{GS}$ = ±8V , $V_{DS}$ = 0V			±20	uA

#### On Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	$V_{GS}$ = -4.5V , $I_{D}$ = -0.2A		500	650	
		$V_{GS}$ = -2.5V , $I_{D}$ = -0.15A		700	900	mΩ
		V <sub>GS</sub> = -1.8V , I <sub>D</sub> = -0.1A		1100	1400	11122
		V <sub>GS</sub> = -1.5V , I <sub>D</sub> = -0.1A		1700	2300	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$ , $I_D=-250uA$	-0.3	-0.7	-1.0	V

#### **Dynamic and switching Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
$Q_g$	Total Gate Charge (NOTE 2 · 3)	V <sub>DS</sub> = -10V , V <sub>GS</sub> = -4.5V ,		1	2	
$Q_{gs}$	Gate-Source Charge (NOTE 2 \ 3)	$I_{D}$ = -0.2A		0.28	0.5	nC
$Q_{gd}$	Gate-Drain Charge (NOTE 2 \ 3)	0.27		0.18	0.4	
$T_{d(on)}$	Turn-On Delay Time (NOTE 2 · 3)			8	16	
$T_r$	Rise Time (NOTE 2 \cdot 3)	$V_{DD}$ = -10V , $V_{GS}$ = -4.5V , $R_{G}$ = 10 $\Omega$ , $I_{D}$ = -0.2A		5.2	10	nS
$T_{d(off)}$	Turn-Off Delay Time (NOTE 2 · 3)			30	60	113
$T_f$	Fall Time (NOTE 2 \ 3)			18	36	
C <sub>iss</sub>	Input Capacitance			40	78	
C <sub>oss</sub>	Output Capacitance	$V_{DS}$ = -10V , $V_{GS}$ = 0V , F= 1MHz		15	30	pF
$C_{rss}$	Reverse Transfer Capacitance	1		6.5	13	

### **Drain-Source Diode Characteristics and Ratings**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current	$V_G = V_D = 0V$ , Force Current			-0.25	Α
I <sub>SM</sub>	Pulsed Source Current				-0.5	Α
$V_{SD}$	Diode Forward Voltage	$V_{GS}$ = 0V , $I_{S}$ = -0.2A , $T_{J}$ = 25°C			-1	V

#### NOTES:

- 1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
- 2. The data tested by pulsed, pulse width  $\leq$  300us , duty cycle  $\leq$  2%.
- ${\it 3. Essentially independent of operating temperature.}\\$





#### **Characteristics Curves**

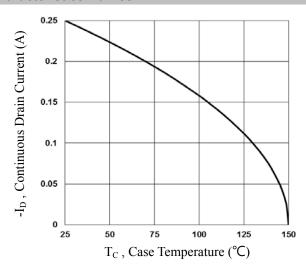


Fig.1 Continuous Drain Current vs. T<sub>c</sub>

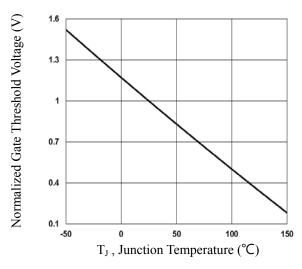


Fig.3 Normalized  $V_{th}$  vs.  $T_J$ 

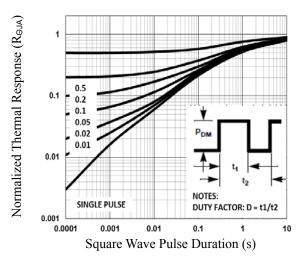


Fig.5 Normalized Transient Response

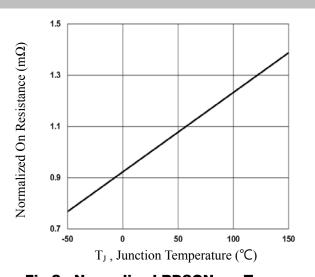


Fig.2 Normalized RDSON vs. T<sub>J</sub>

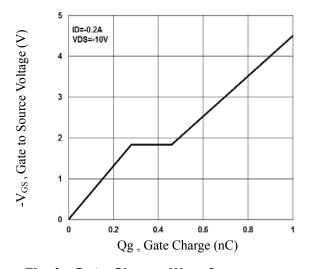


Fig.4 Gate Charge Waveform

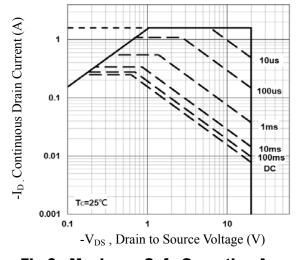
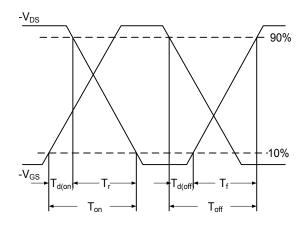


Fig.6 Maximum Safe Operation Area





#### **Characteristics Curves**



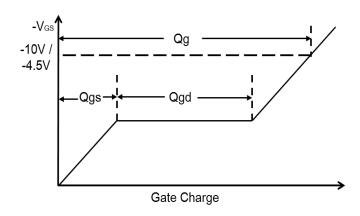
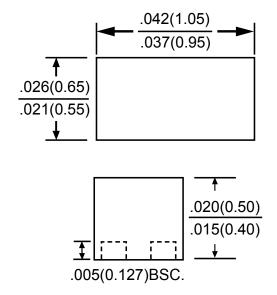
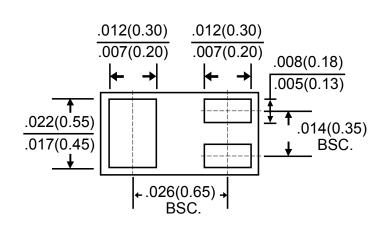


Fig.7 Switching Time Waveform

Fig.8 Gate Charge Waveform

## **Package Outline Dimensions**





**SOT-883**Dimensions in inches and (millimeters)





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